


INT-A-PAK "Half-Bridge" (Ultrafast Speed IGBT), 138 A


INT-A-PAK
FEATURES

- Generation 5 Non Punch Through (NPT) technology
- Ultrafast: Optimized for hard switching speed 8 kHz to 60 kHz
- Low $V_{CE(on)}$
- 10 μ s short circuit capability
- Square RBSOA
- Positive $V_{CE(on)}$ temperature coefficient
- HEXFRED[®] antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al_2O_3 DBC
- UL approved file E78996 
- Compliant to RoHS directive 2002/95/EC
- Designed for industrial level


RoHS
COMPLIANT

PRODUCT SUMMARY	
V_{CES}	600 V
I_C DC	138 A
$V_{CE(on)}$ at 150 A, 25 °C	2.64 V

BENEFITS

- Benchmark efficiency for UPS and welding application
- Rugged transient performance
- Direct mounting on heatsink
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V_{CES}		600	V
Continuous collector current	I_C	$T_C = 25\text{ °C}$	138	A
		$T_C = 80\text{ °C}$	93	
Pulsed collector current	I_{CM}		300	
Clamped inductive load current	I_{LM}		300	
Diode continuous forward current	I_F	$T_C = 25\text{ °C}$	178	
		$T_C = 80\text{ °C}$	121	
Gate to emitter voltage	V_{GE}		± 20	V
Maximum power dissipation	P_D	$T_C = 25\text{ °C}$	500	W
		$T_C = 80\text{ °C}$	280	
Isolation voltage	V_{ISOL}	Any terminal to case, $t = 1\text{ min}$	2500	V

ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	$V_{BR(CE)}$	$V_{GE} = 0\text{ V}, I_C = 500\text{ }\mu\text{A}$	600	-	-	V
Collector to emitter voltage	$V_{CE(on)}$	$V_{GE} = 15\text{ V}, I_C = 100\text{ A}$	-	2.2	2.7	
		$V_{GE} = 15\text{ V}, I_C = 150\text{ A}$	-	2.64	3	
		$V_{GE} = 15\text{ V}, I_C = 100\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	2.68	3.11	
		$V_{GE} = 15\text{ V}, I_C = 150\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	3.25	3.79	
Gate threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 500\text{ }\mu\text{A}$	3	4.2	6	
Collector to emitter leakage current	I_{CES}	$V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}$	-	0.01	0.2	mA
		$V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}, T_J = 150\text{ }^\circ\text{C}$	-	7.5	15	
Diode forward voltage drop	V_{FM}	$I_C = 100\text{ A}$	-	1.39	1.78	V
		$I_C = 150\text{ A}$	-	1.52	1.91	
		$I_C = 100\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	1.31	1.72	
		$I_C = 150\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	1.49	2.05	
Gate to emitter leakage current	I_{GES}	$V_{GE} = \pm 20\text{ V}$	-	-	± 200	nA

SWITCHING CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on switching loss	E_{on}	$I_C = 150\text{ A}, V_{CC} = 360\text{ V}, V_{GE} = 15\text{ V}, R_g = 10\text{ }\Omega, L = 200\text{ }\mu\text{H}, T_J = 25\text{ }^\circ\text{C}$	-	2.0	-	mJ
Turn-off switching loss	E_{off}		-	3.9	-	
Total switching loss	E_{tot}		-	5.9	-	
Turn-on switching loss	E_{on}	$I_C = 150\text{ A}, V_{CC} = 360\text{ V}, V_{GE} = 15\text{ V}, R_g = 10\text{ }\Omega, L = 200\text{ }\mu\text{H}, T_J = 125\text{ }^\circ\text{C}$	-	2.42	-	ns
Turn-off switching loss	E_{off}		-	4.2	-	
Total switching loss	E_{tot}		-	6.62	-	
Turn-on delay time	$t_{d(on)}$		-	390	-	
Rise time	t_r		-	100	-	
Turn-off delay time	$t_{d(off)}$		-	402	-	
Fall time	t_f		-	80	-	
Reverse bias safe operating area	RBSOA	$T_J = 150\text{ }^\circ\text{C}, I_C = 300\text{ A}, R_g = 10\text{ }\Omega, V_{GE} = 15\text{ V to }0$	Fullsquare			
Short circuit safe operating area	SCSOA	$T_J = 150\text{ }^\circ\text{C}, V_{CC} = 400\text{ V}, V_P = 600\text{ V}, R_g = 10\text{ }\Omega, V_{GE} = 15\text{ V to }0$	10	-	-	
Diode reverse recovery time	t_{rr}	$I_F = 50\text{ A}, di_F/dt = 200\text{ A}/\mu\text{s}, V_{CC} = 400\text{ V}, T_J = 25\text{ }^\circ\text{C}$	-	226	260	ns
Diode peak reverse current	I_{rr}		-	17	20	A
Diode recovery charge	Q_{rr}		-	1900	2600	nC
Diode reverse recovery time	t_{rr}	$I_F = 50\text{ A}, di_F/dt = 200\text{ A}/\mu\text{s}, V_{CC} = 400\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	290	330	ns
Diode peak reverse current	I_{rr}		-	25	30	A
Diode recovery charge	Q_{rr}		-	3600	5000	nC



THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS
Operating junction and storage temperature range	T_J, T_{Stg}	- 40	-	150	$^{\circ}\text{C}$
Junction to case per leg	IGBT	-	0.17	0.25	$^{\circ}\text{C}/\text{W}$
	Diode	-	0.19	0.32	
Case to sink per module	R_{thCS}	-	0.1	-	
Mounting torque	case to heatsink	-	-	4	Nm
	case to terminal 1, 2, 3	-	-	3	
Weight		-	185	-	g

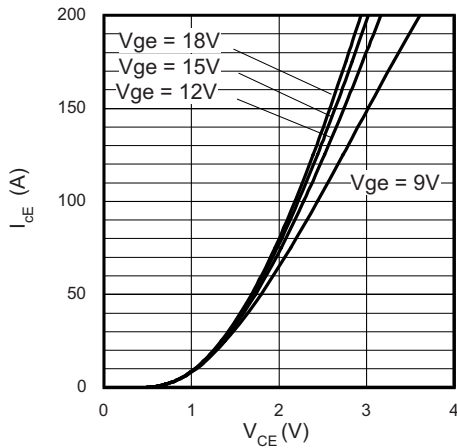


Fig. 1 - Typical IGBT Output Characteristics
 $T_J = 25^{\circ}\text{C}$, $t_p = 500 \mu\text{s}$

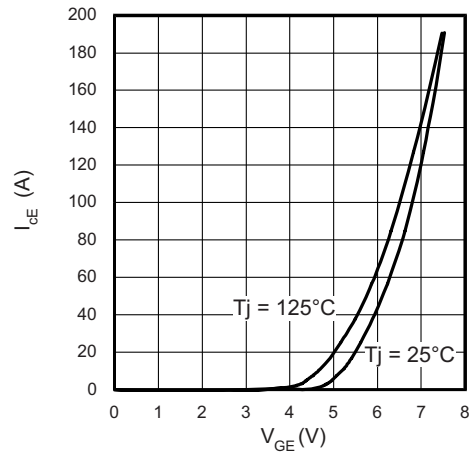


Fig. 3 - Typical Transfer Characteristics
 $V_{CE} = 20 \text{ V}$, $t_p = 500 \mu\text{s}$

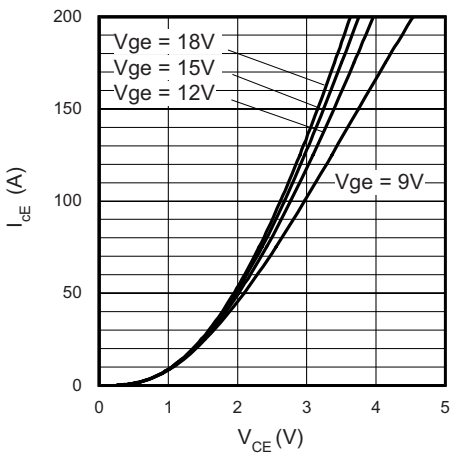


Fig. 2 - Typical IGBT Output Characteristics
 $T_J = 125^{\circ}\text{C}$, $t_p = 500 \mu\text{s}$

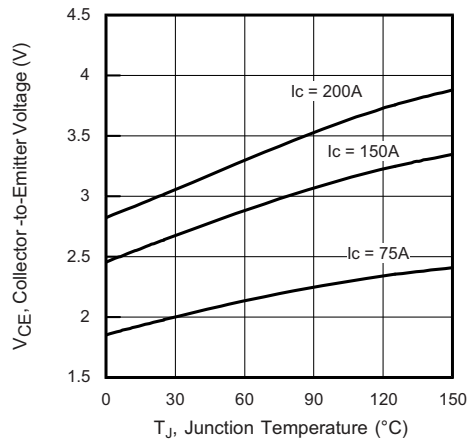


Fig. 4 - Typical Collector to Emitter Voltage vs. Junction Temperature
 $V_{GE} = 15 \text{ V}$, $500 \mu\text{s}$ pulse width

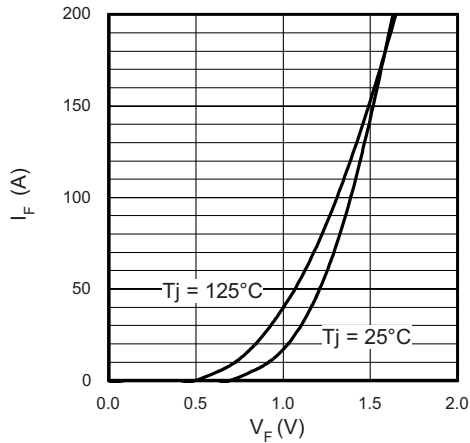


Fig. 5 - Diode Forward Characteristics, $t_p = 500 \mu s$

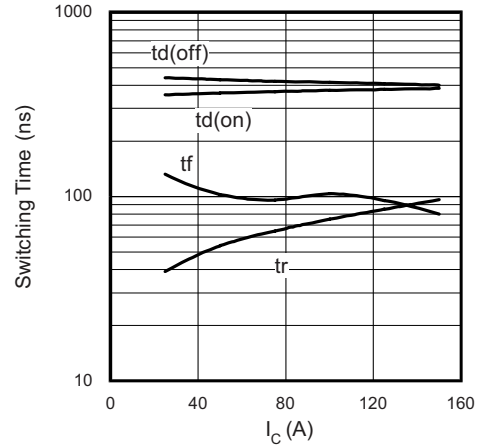


Fig. 8 - Typical Switching Time vs. I_C
 $T_J = 125^\circ C$, $L = 200 \mu H$, $V_{CC} = 360 V$,
 $R_g = 10 \Omega$, $V_{GE} = 15 V$

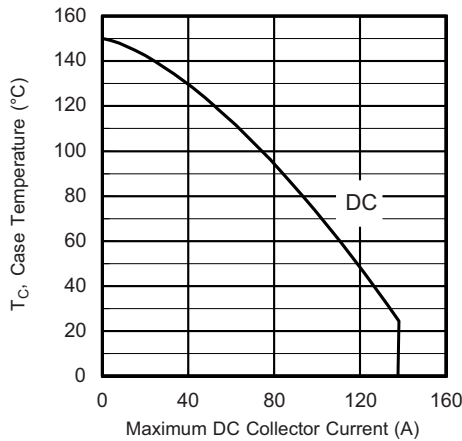


Fig. 6 - Maximum Collector Current vs. Case Temperature

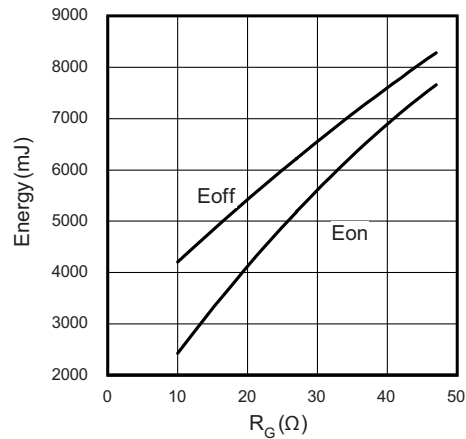


Fig. 9 - Typical Energy Loss vs. R_g
 $T_J = 125^\circ C$, $L = 200 \mu H$, $V_{CC} = 360 V$,
 $I_{CE} = 150 A$, $V_{GE} = 15 V$

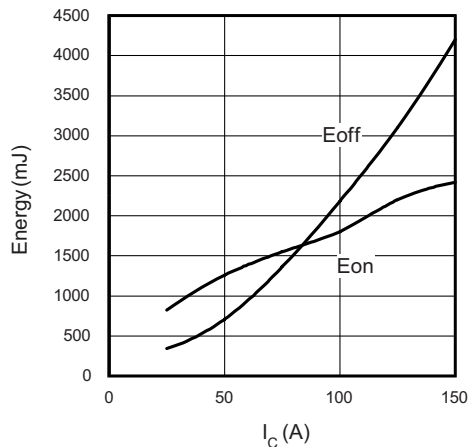


Fig. 7 - Typical Energy Loss vs. I_C
 $T_J = 125^\circ C$, $L = 200 \mu H$, $V_{CC} = 360 V$,
 $R_g = 10 \Omega$, $V_{GE} = 15 V$

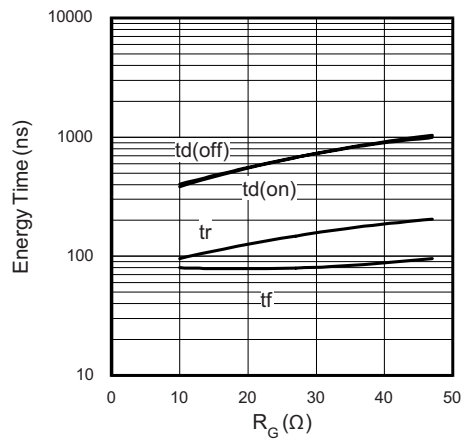
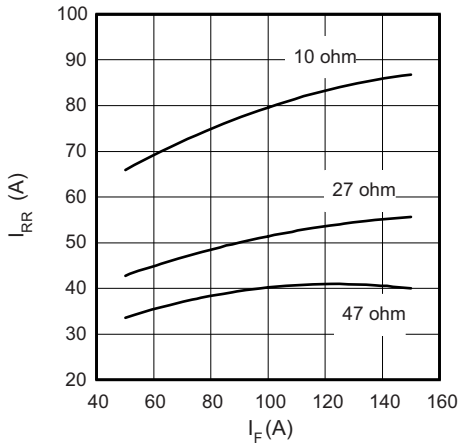
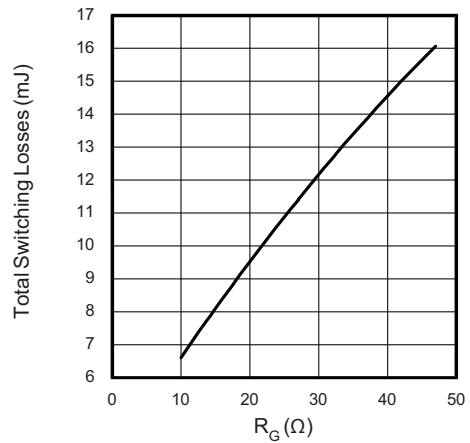
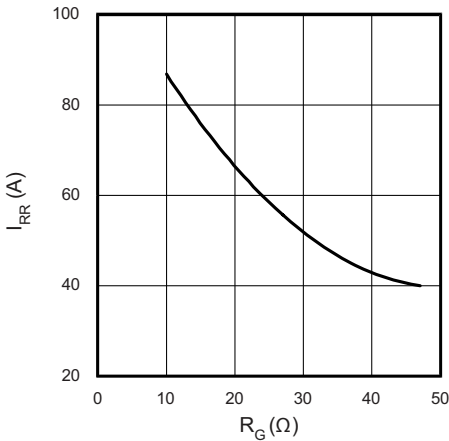
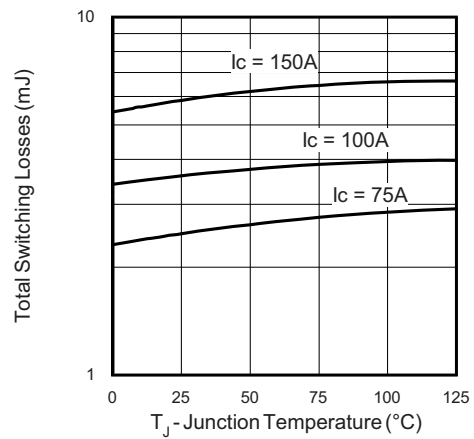
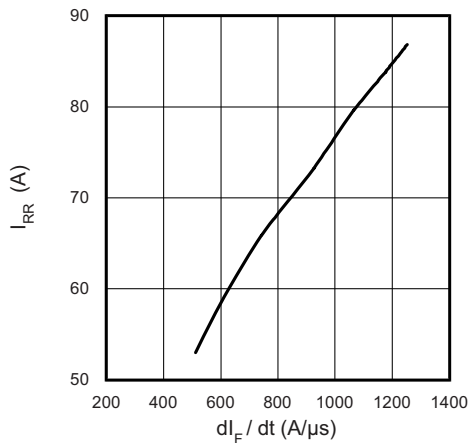
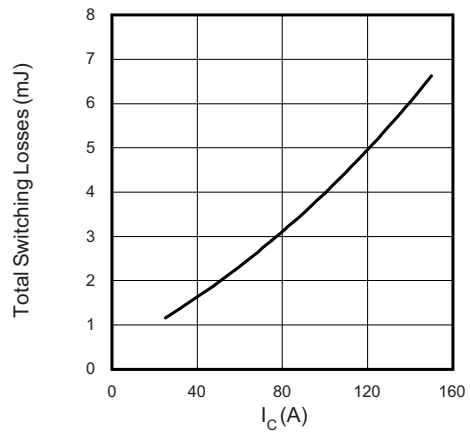


Fig. 10 - Typical Switching Time vs. R_g
 $T_J = 125^\circ C$, $L = 200 \mu H$, $V_{CC} = 360 V$,
 $I_{CE} = 150 A$, $V_{GE} = 15 V$

INT-A-PAK "Half-Bridge" Vishay High Power Products
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 Fig. 11 - Typical Diode I_{rr} vs. I_F
 $T_J = 125^\circ\text{C}$

 Fig. 14 - Typical Switching Losses vs. Gate Resistance,
 $T_J = 125^\circ\text{C}$, $L = 200\ \mu\text{H}$, $R_g = 10\ \Omega$, $V_{CC} = 360\ \text{V}$, $V_{GE} = 15\ \text{V}$

 Fig. 12 - Typical Diode I_{rr} vs. R_g
 $T_J = 125^\circ\text{C}$, $I_F = 150\ \text{A}$

 Fig. 15 - Typical Switching Losses vs. Junction Temperature;
 $L = 200\ \mu\text{H}$, $R_g = 10\ \Omega$, $V_{CC} = 360\ \text{V}$, $V_{GE} = 15\ \text{V}$

 Fig. 13 - Typical Diode I_{rr} vs. di_F/dt
 $T_J = 125^\circ\text{C}$, $V_{CC} = 360\ \text{V}$, $I_F = 150\ \text{A}$, $V_{GE} = 15\ \text{V}$

 Fig. 16 - Typical Switching Losses vs. Collector to Emitter Current;
 $T_J = 125^\circ\text{C}$, $R_{g1} = 10\ \Omega$, $R_{g2} = 0\ \Omega$, $V_{CC} = 360\ \text{V}$, $V_{GE} = 15\ \text{V}$

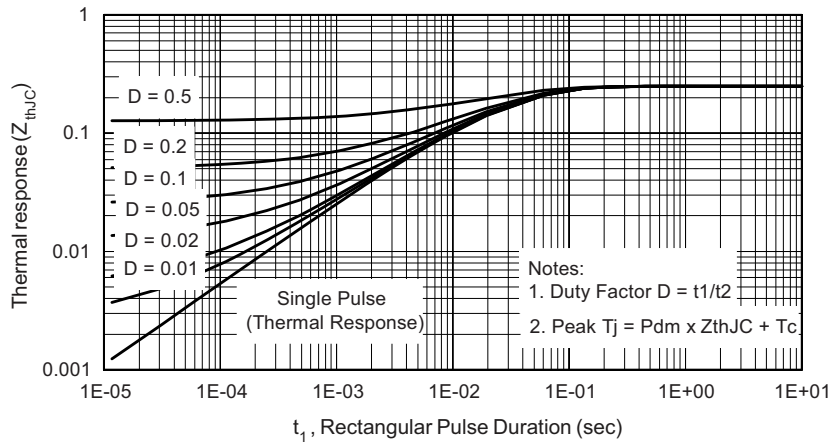


Fig. 17 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

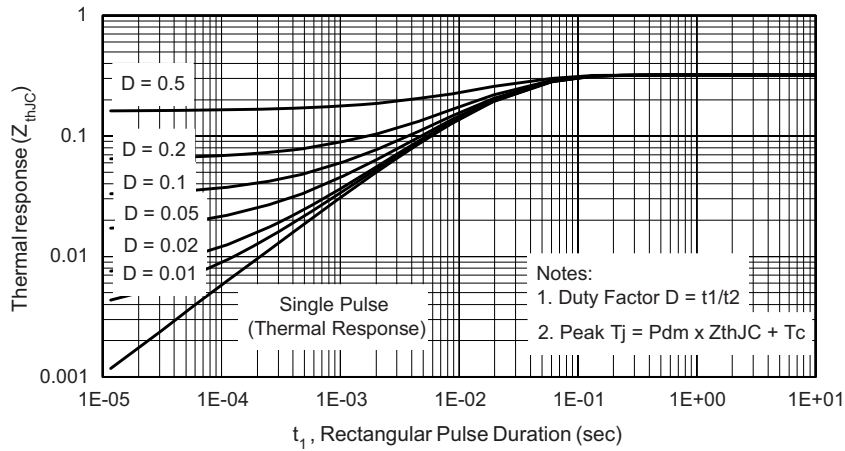
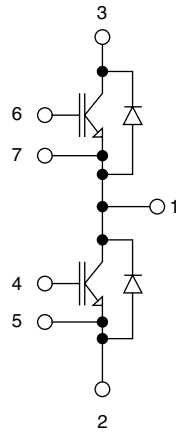


Fig. 18 - Maximum Transient Thermal Impedance, Junction to Case (HEXFRED®)

ORDERING INFORMATION TABLE

Device code	G	B	150	T	S	60	N	PbF
	①	②	③	④	⑤	⑥	⑦	⑧

- 1** - Insulated Gate Bipolar Transistor (IGBT)
- 2** - B = IGBT Generation 5 NPT
- 3** - Current rating (150 = 150 A)
- 4** - Circuit configuration (T = Half-bridge)
- 5** - Package indicator (S = INT-A-PAK)
- 6** - Voltage rating (60 = 600 V)
- 7** - Speed/type (N = Ultrafast IGBT)
- 8** - Lead (Pb)-free

CIRCUIT CONFIGURATION

LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95173
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INT-A-PAK IGBT/Thyristor

DIMENSIONS in millimeters (inches)





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